# INTEGRATED CIRCUITS



Product data Supersedes data of 2001 Jun 19

2002 Sep 13



Philips Semiconductors

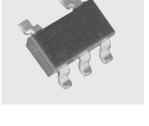
#### **GENERAL DESCRIPTION**

The SA56614-XX is a CMOS device designed to generate a reset signal for a variety of microprocessor and logic systems. Accurate reset signals are generated during momentary power interruptions, or whenever power supply voltages sag to intolerable levels. Several reset threshold versions of the device are available. A totem-pole output topology is incorporated to provide both current source and sink capability to the user.

SA56614-XX is available in the SOT23-5 surface mount package.

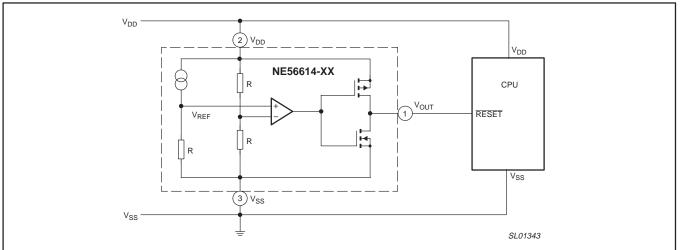
#### FEATURES

- 10 V<sub>DC</sub> maximum operating voltage
- Low operating voltage (0.95 V)
- Totem pole CMOS output
- Offered in reset thresholds of 1.85, 2.0, 2.7, 2.8, 2.9, 3.0, 3.1, 4.2, 4.3, 4.4, 4.5, 4.6, 4.7 V<sub>DC</sub>
- Available in SOT23-5 surface mount package



#### **APPLICATIONS**

- Microcomputer systems
- Logic systems
- Battery monitoring systems
- Back-up power supply circuits
- Voltage detection circuits



#### Figure 1. Simplified system diagram.

#### SIMPLIFIED SYSTEM DIAGRAM

## SA56614-XX

## SA56614-XX

#### **ORDERING INFORMATION**

TYPE NUMBER	PACKAGE	TEMPERATURE RANGE	
NAME			
SA56614- <b>XX</b> GW	SOT23-5, SOT25, SO5 plastic small outline package; 5 leads (see dimensional drawing)		–40 to +85 °C

#### NOTE:

The device has twelve detection voltage options, indicated by the XX on the 'Type number'.

XX	DETECT VOLTAGE (Typical)
185	1.85 V
20	2.0 V
27	2.7 V
28	2.8 V
29	2.9 V
30	3.0 V
31	3.1 V
42	4.2 V
43	4.3 ∨
44	4.4 V
45	4.5 V
46	4.6 V
47	4.7 V

### **PIN CONFIGURATION**

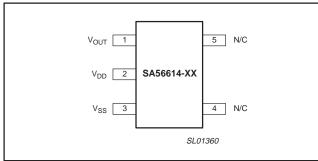


Figure 2. Pin configuration.

#### **MAXIMUM RATINGS**

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V <sub>DD</sub>	Power supply voltage	-	12	V
V <sub>OUT</sub>	Output voltage	V <sub>SS</sub> – 0.3	V <sub>DD</sub> + 0.3	V
I <sub>OUT</sub>	Output current	-	50	mA
T <sub>oper</sub>	Operating temperature	-40	85	°C
T <sub>stg</sub>	Storage temperature	-40	125	°C
Р	Power dissipation	_	150	mW

#### **PIN DESCRIPTION**

PIN	SYMBOL	DESCRIPTION	
1	V <sub>OUT</sub>	Reset HIGH output.	
2	V <sub>DD</sub>	Positive supply.	
3	V <sub>SS</sub>	Ground. Negative supply.	
4	N/C	No connection.	
5	N/C	No connection.	

# SA56614-XX

#### DC ELECTRICAL CHARACTERISTICS

Characteristics measured with  $T_{amb}$  = 25 °C, unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	TEST CIRCUIT	MIN.	TYP.	MAX.	UNIT
VS	Reset detection threshold			V <sub>S</sub> – 2%	Vs	V <sub>S</sub> + 2%	V
$\Delta V_{S}$	Hysteresis	$V_{DD} = 0 \text{ V} \rightarrow V_{S} + 1.0 \text{ V} \rightarrow 0 \text{ V}$	1	$V_{S}  imes 0.03$	$V_{S} \times 0.05$	$V_{S} \times 0.08$	V
V <sub>S</sub> /∆T	Threshold voltage temperature coefficient	$-40 \text{ °C} \le T_{amb} \le +85 \text{ °C}$	1 Fig. 16	-	±0.01	-	%/°C
I <sub>CC</sub>	Supply current	V <sub>DD</sub> = V <sub>S</sub> + 1.0 V	]	-	0.25	1.0	μΑ
I <sub>OH</sub>	I <sub>DS</sub> leakage current when OFF	$V_{DD} = V_{DS} = 10 V$	3 Fig. 18	-	-	0.1	μA
I <sub>NDS1</sub>	N-channel I <sub>DS</sub> output sink current 1	$V_{DD}$ = 1.2 V; $V_{DS}$ = 0.5 V		-0.23	0.50	-	mA
I <sub>NDS2</sub>	N-channel I <sub>DS</sub> output sink current 2 (for V <sub>S</sub> > 2.6 V)	$V_{DS} = 0.5 \text{ V}; V_{DD} = 2.4 \text{ V}$	2 Fig. 17	-1.6	-3.7	-	mA
I <sub>NDS3</sub>	N-channel I <sub>DS</sub> output sink current 3 (for V <sub>S</sub> > 3.9 V)	$V_{DS} = 0.5 \text{ V}; V_{DD} = 3.6 \text{ V}$		-3.2	-7.00	-	mA
I <sub>PDS1</sub>	P-channel I <sub>DS</sub> output source current 1 (for $V_S < 4.0 V$ )	$V_{DS} = 0.5 \text{ V}; V_{DD} = 4.8 \text{ V}$		0.36	0.62	-	mA
I <sub>PDS2</sub>	P-channel I <sub>DS</sub> output source current 2 (for 4.0 V < V <sub>S</sub> < 5.7 V)	$V_{DS} = 0.5 \text{ V}; V_{DD} = 6.0 \text{ V}$	3 Fig. 18	0.46	0.75	_	mA
I <sub>PDS3</sub>	P-channel $I_{DS}$ output source current 3 (for $V_S \ge 5.7 V$ )	$V_{DS} = 0.5 \text{ V}; V_{DD} = 8.4 \text{ V}$	]	0.59	0.96	-	mA

## Product data

## SA56614-XX

#### **TYPICAL PERFORMANCE CURVES**

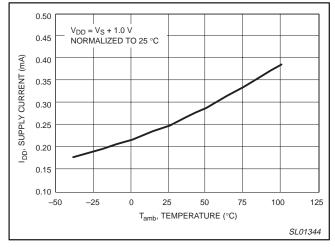


Figure 3. Supply current versus temperature.

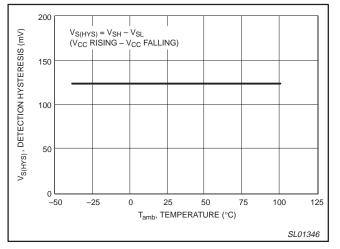


Figure 5. Detection hysteresis versus temperature.

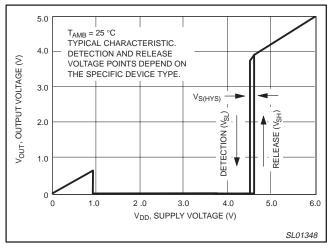


Figure 7. Output voltage versus supply voltage.

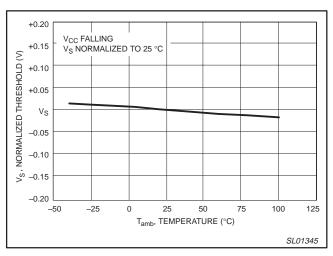


Figure 4. Detection threshold versus temperature.

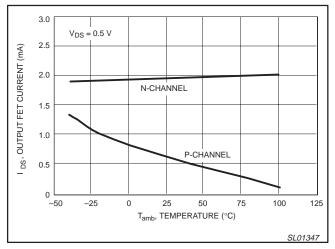


Figure 6. Output FET current versus temperature.

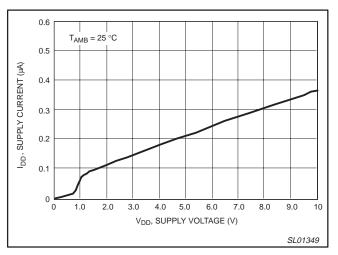


Figure 8. Supply current versus supply voltage.

## SA56614-XX

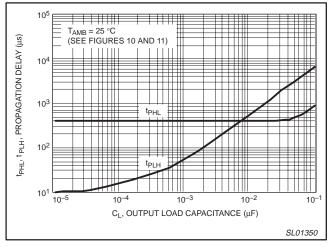


Figure 9. Propagation delay versus output load C.

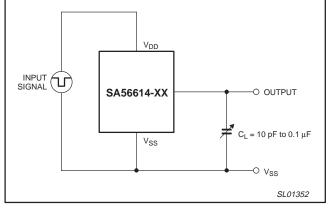


Figure 11. Propagation delay measurement circuit.

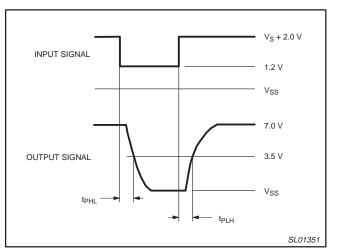


Figure 10. Propagation delay measurements.

## SA56614-XX

#### **TECHNICAL DESCRIPTION**

The SA56614-XX is a CMOS device designed to monitor the system's power source and provide a system reset function in the event the supply voltage sags below an acceptable level for the system to reliably operate. The SA56614 generates a compatible reset signal for a wide variety of microprocessor and logic systems. The reset threshold incorporates a typical hysteresis of  $(V_S \times 0.05)$  volts to prevent erratic resets from being generated. The SA56614 operates at very low supply currents, typically 0.25  $\mu$ A, while offering a high precision of threshold detection (±2%).

The output of the SA56614 incorporates an active Totem-Pole output topology comprised of complimentary P-Channel and N-Channel FETs. A P-Channel FET is on the high supply side and when ON pulls the output to or near the  $V_{DD}$  supply voltage from which output source current can be obtained. A complimentary N-Channel FET is on the low or ground side, and actively pulls the output LOW or to ground with the capability of sinking current into the output. Both devices supply system reset signals. The user should keep in mind, when connecting the SA56614 to a system, the effect of supplying source current from the output of the SA56614 on the system. This is of particular importance where the SA56614 is operated from a different supply source than the rest of the system.

Figure 12 is a functional block diagram of the SA56614. The internal reference source voltage (V<sub>REF</sub>) is typically 0.8 V over the operating temperature range. The reference voltage is connected to the non-inverting input of the threshold comparator while the inverting input monitors the supply voltage through a resistor divider network made up of R<sub>1</sub>, R<sub>2</sub>, and R<sub>3</sub>. The output of the threshold comparator drives the totem-pole output stage of the device.

When the supply voltage sags to the threshold detection voltage, the resistor divider network supplies a voltage to the inverting input of the threshold comparator which is less than that of  $V_{REF}$ , causing the output of the comparator to adopt a HIGH output state. This causes the high side P-Channel FET of the Totem-Pole output stage to turn OFF while simultaneously turning the low side N-Channel FET from OFF to an active ON state, pulling the output to a LOW voltage state. The device adheres to a true input/output logic protocol. The output goes to a LOW voltage state when input is

LOW (below  $V_S)$  and the output HIGH goes to a HIGH voltage state when the input is HIGH (above  $V_S).$ 

The low side N-Channel FET (TR<sub>3</sub>) establishes threshold hysteresis by turning ON whenever the threshold comparator's output goes to a HIGH state (when V<sub>DD</sub> sags to or below the threshold level). TR<sub>3</sub>'s turning ON causes additional current to flow through resistors R<sub>1</sub>, and R<sub>2</sub> causing the inverting input of the threshold comparator to be pulled even lower. For the comparator to reverse its output polarity and turn OFF TR<sub>3</sub>, the V<sub>DD</sub> source voltage must overcome this additional pull-down voltage present on the comparator's inverting input. The differential voltage required to do this establishes the hysteresis voltage of the sensed threshold voltage. Typically it is (V<sub>S</sub> × 0.05) volts.

When the V<sub>DD</sub> voltage sags and is at or below the Detection Threshold (V<sub>SL</sub>), the device will assert a Reset LOW output at or very near ground potential. As the V<sub>DD</sub> voltage rises from (V<sub>DD</sub> < V<sub>SL</sub>) to V<sub>SH</sub> or higher, the reset is released and the output follows V<sub>DD</sub>. Conversely, decreases in V<sub>DD</sub> from (V<sub>DD</sub> > V<sub>SL</sub>) to V<sub>SL</sub> or lower cause the output to be pulled to ground.

Hysteresis Voltage = Release Voltage – Detection Threshold Voltage

$$V_{HYS} = V_{SH} -$$
  
where:

$$V_{SH} = V_{SL} + V_{HYS} \cong V_{REF}(R_1 + R_2) / R_2$$

VSL

$$V_{SL} = V_{REF}(R_1 + R_2 + R_3) / (R_2 + R_3)$$

When  $V_{DD}$  drops below the minimum operating voltage, typically less than 0.95 volts, the output is undefined and output reset low assertion is not guaranteed. At this level of  $V_{DD}$  the output will try to rise to  $V_{DD}$ .

The V<sub>REF</sub> voltage is typically 0.8 V. The devices are fabricated using a high resistance CMOS process and utilize high resistance R<sub>1</sub>, R<sub>2</sub>, and R<sub>3</sub> values requiring very small amounts of current. This combination achieves very efficient low power performance over the full operating temperature.

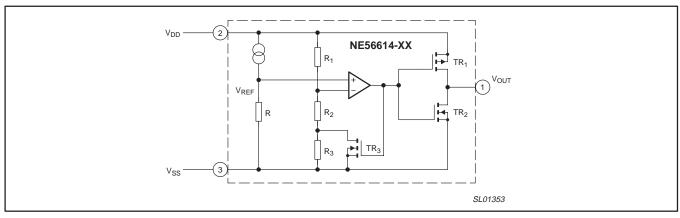


Figure 12. Functional diagram

## SA56614-XX

#### **TIMING DIAGRAM**

The timing diagram shown in Figure 13 depicts the operation of the device. Letters A-J on the TIME axis indicate specific events.

A: At 'A',  $V_{DD}$  begins to increase. Also the  $V_{OUT}$  voltage initially increases but abruptly decreases when  $V_{DD}$  reaches the level (approximately 0.8 V) that activates the internal bias circuitry and RESET is asserted.

**B:** At 'B', V<sub>DD</sub> reaches the threshold level of V<sub>SH</sub>. At this point the device releases the hold on the V<sub>OUT</sub> reset. The Reset output V<sub>OUT</sub> tracks V<sub>DD</sub> as it rises above V<sub>SH</sub> (assuming the reset pull-up resistor R<sub>PU</sub> is connected to V<sub>DD</sub>). In a microprocessor based system these events release the reset from the microprocessor, allowing the microprocessor to function normally.

**C-D:** At 'C', V<sub>DD</sub> begins to fall, causing V<sub>OUT</sub> to follow. V<sub>DD</sub> continues to fall until the V<sub>SL</sub> undervoltage detection threshold is reached at 'D'. This causes a reset signal to be generated (V<sub>OUT</sub> Reset goes LOW).

D-E: Between 'D' and 'E', V<sub>DD</sub> starts rising.

E: At 'E', V<sub>DD</sub> rises to the V<sub>SH</sub>. Once again, the device releases the hold on the V<sub>OUT</sub> reset. The Reset output V<sub>OUT</sub> tracks V<sub>DD</sub> as it rises above V<sub>SH</sub>.

**F-G:** At 'F', V<sub>DD</sub> is above the upper threshold and begins to fall, causing V<sub>OUT</sub> to follow it. As long as V<sub>DD</sub> remains above the V<sub>SH</sub>, no reset signal will be triggered. Before V<sub>DD</sub> falls to the V<sub>SH</sub>, it begins to rise, causing V<sub>OUT</sub> to follow it. At 'G', V<sub>DD</sub> returns to normal.

**H:** At event 'H'  $V_{DD}$  falls until the  $V_{SL}$  undervoltage detection threshold point is reached. At this level, a **RESET** signal is generated and  $V_{OUT}$  goes LOW.

**J:** At 'J' the V<sub>DD</sub> voltage has decreased until normal internal circuit bias is unable to maintain a V<sub>OUT</sub> reset. As a result, V<sub>DD</sub> may rise to less than 0.8 V. As V<sub>DD</sub> decreases further, V<sub>OUT</sub> reset also decreases to zero.

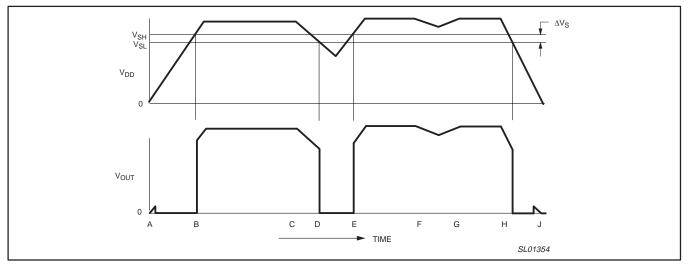


Figure 13. Timing diagram.

## SA56614-XX

#### **APPLICATION INFORMATION**

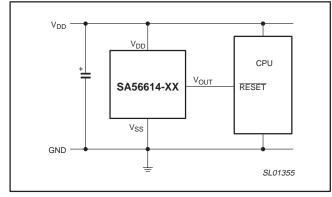


Figure 14. Conventional reset application

Small changes in supply current will occur when the SA56614 asserts or releases a reset. In some cases this can cause oscillations of the device. This can present a problem, particularly where high impedance  $V_{DD}$  sources are employed. Figure 15 shows how this may occur.

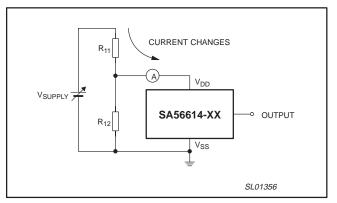
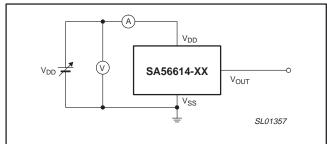


Figure 15. High impedance supply operating problems

Significant voltage variations of V<sub>DD</sub> may occur when the device is operated from high impedance power sources. When the device asserts or releases a reset, V<sub>DD</sub> variations are produced as a result of the voltage drop developed across R<sub>11</sub> due to the current variations through the resistor R<sub>11</sub> (representing the supply impedance). If the V<sub>DD</sub> variations are large, such that they exceed the Detection Hysteresis, the output of the device can oscillate from a HIGH state to a LOW state. The user should avoid using high impedance V<sub>DD</sub> sources to prevent such situations.

#### **TEST CIRCUITS**





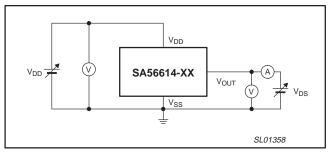


Figure 17. Test Circuit 2

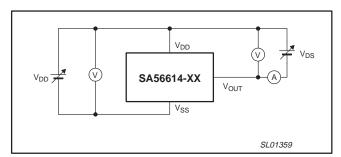


Figure 18. Test Circuit 3

## SA56614-XX

#### **PACKING METHOD**

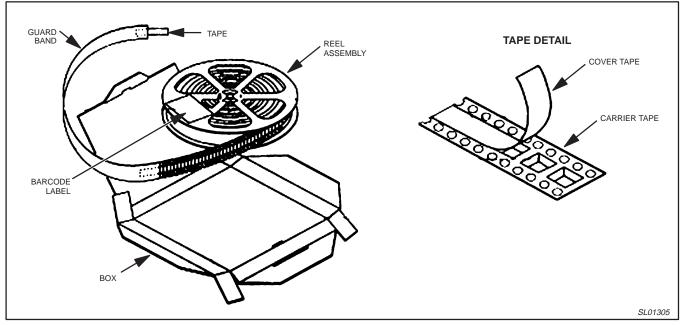
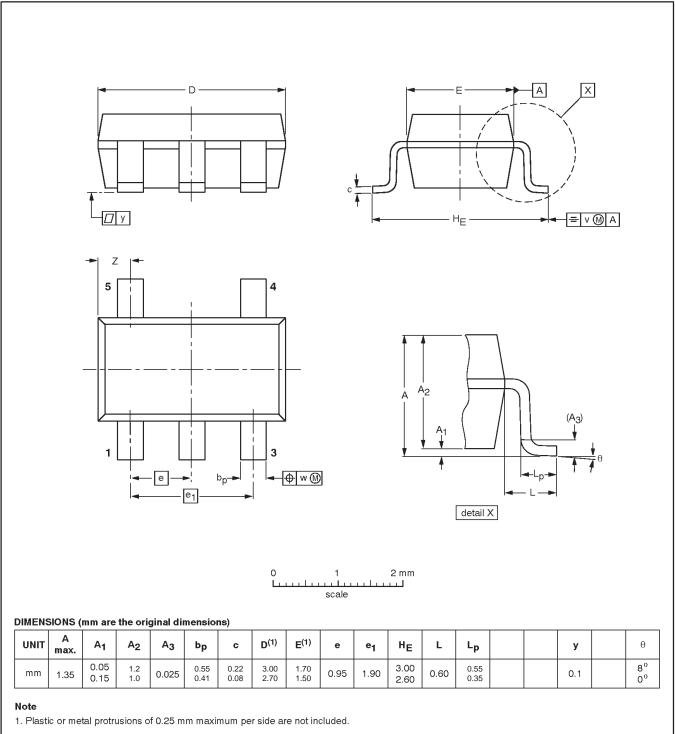


Figure 19. Tape and reel packing method

### SA56614-XX

#### SOT23-5: plastic small outline package; 5 leads; body width 1.5 mm



OUTLINE VERSION	REFERENCES				
	IEC	JEDEC	EIAJ		
		MO-178			

## SA56614-XX

#### Data sheet status

Data sheet status <sup>[1]</sup>	Product status <sup>[2]</sup>	Definitions
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.

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